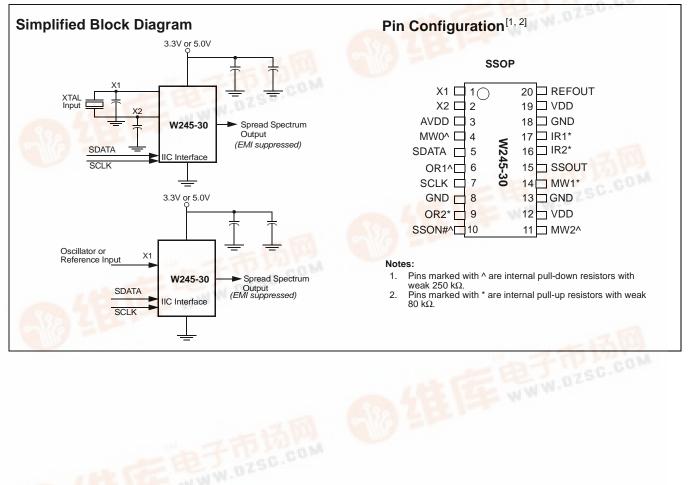


#### Features

- Cypress PREMIS<sup>™</sup> family offering
- Generates an EMI optimized clocking signal at the output
- Selectable output frequency range
- Single 1.25%, 2.5%, 5% or 10% down or center spread output
- Integrated loop filter components
- Operates with a 3.3 or 5V supply
- Low power CMOS design
- Available in 20-pin SSOP (Small Shrunk Outline Package)

## **Key Specifications**

	V <sub>DD</sub> = 3.3V±0.3V
or $V_{DD} = 5V \pm 10\%$	
Frequency range:	13 MHz <u>&lt;</u> F <sub>in</sub> <u>&lt;</u> 120 MHz
Cycle to Cycle Jitter:	250 ps (max)
Output duty cycle:	





# **Pin Description**

Pin Name	Pin No.	Pin Type	Pin Description
SSOUT	15	0	<b>Output Modulated Frequency:</b> Frequency modulated copy of the input clock (SSON# asserted).
REFOUT	20	0	<b>Non-Modulated Output:</b> This pin provides a copy of the reference frequency. This output will not have the Spread Spectrum feature enabled regardless of the state of logic input SSON#.
X1	1	I	<b>Crystal Connection or External Reference Frequency Input:</b> This pin has dual functions. It may either be connected to an external crystal, or to an external reference clock.
X2	2	I	<i>Crystal Connection:</i> Input connection for an external crystal. If using an external reference, this pin must be left unconnected.
SSON#	10	I	<b>Spread Spectrum Control (Active LOW):</b> Asserting this signal (active LOW) turns the internal modulation waveform on. This pin has an internal pull-down resistor.
MW0:2	4, 11, 14	I	<b>Modulation Width Selection:</b> When Spread Spectrum feature is turned on, these pins are used to select the amount of variation and peak EMI reduction that is desired on the output signal. MW1:Down, MW1:Up, MW2:Down (See <i>Table 2</i> ).
IR1:2	17, 16	I	<b>Reference Frequency Selection:</b> Logic level provided at this input indicates to the internal logic what range the reference frequency is in and determines the factor by which the device multiplies the input frequency. Refer to <i>Table 3</i> . These pins have internal pull-up resistors.
OR1:2	6, 9	I	<b>Output Frequency Selection Bits:</b> These pins select the frequency operation for the output. Refer to <i>Table 1</i> . OR2 pin have internal pull-up resistors. OR1 pin have internal pull-down resistors.
SCLK	7	I	Clock pin for SMBus circuitry.
SData	5	I/O	Data pin for SMBus Circuitry.
VDD	12, 19	Р	Power Connection: Connected to 3.3V or 5V power supply.
AVDD	3	Р	Analog Power Connection: Connected to 3.3V or 5V power supply.
GND	8, 13, 18	G	Ground Connection: Connect all ground pins to the common ground plane.



Range of Fin Multiplier Output / **Required R** Modulation & Pow-Frequency Input **Range of Fout** Settings er Down Settings Settings Min. Max. OR2 OR1 Min. Max. IR2 IR1 MW2 MW1 14 30 0 14 30 0 1 Table 2 1 1 2 14 30 1 0 28 60 0 1 Table 2 14 30 1 1 4 56 120 0 1 Table 2 25 60 0 1 0.5 13 30 1 0 Table 2 25 60 1 0 1 25 60 1 0 Table 2 2 25 60 1 1 50 120 1 0 Table 2 50 120 0 1 0.25 13 30 1 1 Table 2 50 120 1 0 0.5 25 60 1 1 Table 2 1 50 120 1 1 1 50 120 1 Table 2 Reserved 0 0 N/A N/A N/A As Set As Set 1 0 Power Down Hi-Z 0 0 N/A N/A N/A As Set 1 1 As Set N/A N/A Power Down 0 0 0 N/A As Set As Set 0 0 Power Down 1 0 N/A N/A N/A As Set 0 As Set 0 1

#### Table 1. Frequency Configuration (Frequencies in MHz)

#### Table 2. Modulation Width Selection Table

EMI Reduction	Modulat	ion Setting	Bandwi	th Limit Freq	uencies as a% Value of Fout		
			MW0 = 0			MW0 = 1	
	MW2	MW1	Low	High	Low	High	
Minimum EMI Control	0	0	98.75%	100%	99.375%	100.625	
Suggested Setting	0	1	97.5%	100%	98.75	101.25%	
Alternate Setting	1	0	95.0%	100%	97.5%	102.5%	
Maximum EMI reduction	1	1	90.0%	100%	95%	105%	

#### **Overview**

The W245-30 product is one of a series of devices in the Cypress PREMIS family. The PREMIS family incorporates the latest advances in PLL spread spectrum frequency synthesizer techniques. By frequency modulating the output with a low frequency carrier, peak EMI is greatly reduced. Use of this technology allows systems to pass increasingly difficult EMI testing without resorting to costly shielding or redesign.

In a system, not only is EMI reduced in the various clock lines, but also in all signals which are synchronized to the clock. Therefore, the benefits of using this technology increase with the number of address and data lines in the system. The Simplified Block Diagram shows a simple implementation.

## **Functional Description**

The W245-30 uses a phase locked loop (PLL) to frequency modulate an input clock. The result is an output clock whose frequency is slowly swept over a narrow band near the input signal. The basic circuit topology is shown in *Figure 1*. The input reference signal is divided by Q and fed to the phase detector. A signal from the VCO is divided by P and fed back to the phase detector also. The PLL will force the frequency of the VCO output signal to change until the divided output signal and the divided reference signal match at the phase detector input. The output frequency is then equal to the ratio of P/Q times the reference frequency. (Note: For the W245-30 the output frequency is nominally equal to the input frequency.) The unique feature of the Spread Spectrum Frequency Timing Generator is that a modulating waveform is superimposed at the input to the VCO. This causes the VCO output to be slowly swept across a predetermined frequency band.

Because the modulating frequency is typically 1000 times slower than the fundamental clock, the spread spectrum process has little impact on system performance.

#### **Frequency Selection With SSFTG**

In Spread Spectrum Frequency Timing Generation, EMI reduction depends on the shape, modulation percentage, and frequency of the modulating waveform. While the shape and frequency of the modulating waveform are fixed for a given frequency, the modulation percentage may be varied.

Using frequency select bits (FS2:1 pins), the frequency range can be set (see *Table 2*). Spreading percentage is set with pins MW0:2 as shown in *Table 2*.

A larger spreading percentage improves EMI reduction. However, large spread percentages may either exceed system maximum frequency ratings or lower the average frequency to a point where performance is affected. For these reasons, spreading percentage options are provided.



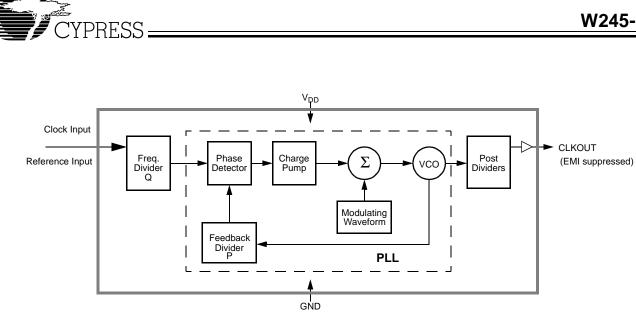


Figure 1. Functional Block Diagram



## **Spread Spectrum Frequency Timing Generator**

The device generates a clock that is frequency modulated in order to increase the bandwidth that it occupies. By increasing the bandwidth of the fundamental and its harmonics, the amplitudes of the radiated electromagnetic emissions are reduced. This effect is depicted in *Figure 2*.

As shown in *Figure 2*, a harmonic of a modulated clock has a much lower amplitude than that of an unmodulated signal. The reduction in amplitude is dependent on the harmonic number and the frequency deviation or spread. The equation for the reduction is

Where P is the percentage of deviation and F is the frequency in MHz where the reduction is measured.

The output clock is modulated with a waveform depicted in *Figure 3*. This waveform, as discussed in "Spread Spectrum Clock Generation for the Reduction of Radiated Emissions" by Bush, Fessler, and Hardin produces the maximum reduction in the amplitude of radiated electromagnetic emissions. The deviation selected for this chip is as described in *Table 2*. *Figure 3* details the Cypress spreading pattern. Cypress does offer options with more spread and greater EMI reduction. Contact your local Sales representative for details on these devices.

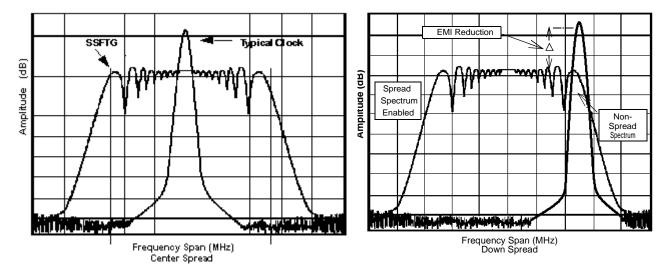
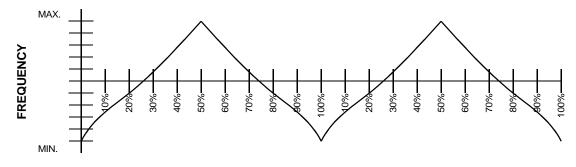


Figure 2. Clock Harmonic with and without SSCG Modulation Frequency Domain Representation



**Figure 3. Typical Modulation Profile** 

 $dB = 6.5 + 9^* \log_{10}(P) + 9^* \log_{10}(F)$ 



## Serial Data Interface

The W245-30 features a two-pin, serial data interface that can be used to configure internal register settings that control particular device functions. Upon power-up, the W245-30 initializes with default register settings, therefore the use of this serial data interface is optional. The serial interface is write-only (to the clock chip) and is the dedicated function of device pins SDATA and SCLOCK. In motherboard applications, SDATA and SCLOCK are typically driven by two logic outputs of the chipset. Clock device register changes are normally made upon system initialization, if any are required. The interface can also be used during system operation for power management functions. *Table 3* summarizes the control functions of the serial data interface.

#### Operation

Data is written to the W245-30 in eleven bytes of eight bits each. Bytes are written in the order shown in *Table 4*.

Control Function	Description	Common Application
Clock Output Disable	Any individual clock output(s) can be disabled. Dis- abled outputs are actively held low.	Unused outputs are disabled to reduce EMI and system power. Examples are clock out- puts to unused PCI slots.
CPU Clock Frequency Selection	Provides CPU/PCI frequency selections through software. Frequency is changed in a smooth and controlled fashion.	For alternate microprocessors and power management options. Smooth frequency transition allows CPU frequency change un- der normal system operation.
Spread Spectrum En- abling	Enables or disables spread spectrum clocking.	For EMI reduction.
Output Three-state	Puts clock output into a high impedance state.	Production PCB testing.
(Reserved)	Reserved function for future device revision or pro- duction device testing.	No user application. Register bit must be writ- ten as 0.

## Table 3. Serial Data Interface Control Functions Summary

#### Table 4. Byte Writing Sequence

Byte Se- quence	Byte Name	Bit Sequence	Byte Description
1	Slave Address	11010010	Commands the W245-30 to accept the bits in Data Bytes 0-6 for internal register configuration. Since other devices may exist on the same common serial data bus, it is necessary to have a specific slave address for each potential receiver. The slave receiver address for the W245-30 is 11010010. Register setting will not be made if the Slave Address is not correct (or is for an alternate slave receiver).
2	Command Code	Don't Care	Unused by the W245-30, therefore bit values are ignored (don't care). This byte must be included in the data write sequence to maintain proper byte allocation. The Command Code Byte is part of the standard serial communication protocol and may be used when writing to another addressed slave receiver on the serial data bus.
3	Byte Count	Don't Care	Unused by the W245-30, therefore bit values are ignored (don't care). This byte must be included in the data write sequence to maintain prop- er byte allocation. The Byte Count Byte is part of the standard serial communication protocol and may be used when writing to another ad- dressed slave receiver on the serial data bus.
4	Data Byte 0	Refer to	The data bits in Data Bytes 0-7 set internal W245-30 registers that
5	Data Byte 1	Table 5	control device operation. The data bits are only accepted when the Address Byte bit sequence is 11010010, as noted above. For descrip-
6	Data Byte 2		tion of bit control functions, refer to Table 3, Data Byte Serial Configu-
7	Data Byte 3		ration Map.
8	Data Byte 4		
9	Data Byte 5		
10	Data Byte 6	]	
11	Data Byte 7		



## Writing Data Bytes

Each bit in Data Bytes 0–7 control a particular device function except for the "reserved" bits which must be written as a logic 0. Bits are written MSB (most significant bit) first, which is bit 7. *Table 5* gives the bit formats for registers located in Data Bytes 0–7.

### Table 5. Data Bytes 0–7 Serial Configuration Map

	Affe	cted Pin		Bit C	ontrol	
Bit(s)	Pin No.	Pin Name	Control Function	0	1	Default
Data By	/te 0			·		
7			(Reserved)			0
6			(Reserved)			0
5			(Reserved)			0
4			(Reserved)			0
3			(Reserved)			0
2			(Reserved)			0
1			(Reserved)			0
0			(Reserved)			0
Data By	/te 1					
7			(Reserved)			0
6			(Reserved)			0
5			(Reserved)			0
4			(Reserved)			0
3			(Reserved)			0
2			(Reserved)			0
1			(Reserved)			0
0			(Reserved)			0
Data By	/te 2					
7			(Reserved)			0
6			(Reserved)			0
5			(Reserved)			0
4			(Reserved)			0
3			(Reserved)			0
2			(Reserved)			0
1			(Reserved)			0
0			(Reserved)			0
Data By	/te 3					
7			(Reserved)			0
6			(Reserved)			0
5			(Reserved)			0
4			(Reserved)			0
3			(Reserved)			0
2			(Reserved)			0
1			(Reserved)			0



W245-30

	Affe	cted Pin		Bit C	ontrol	
Bit(s)	Pin No.	Pin Name	Control Function	0	1	Default
0			(Reserved)			0
Data By	vte 4	I			I	
7	16	IR2	MSB of Input Range Select	Refer to	Table 1	0
6	17	IR1	LSB of Input Range Select	Refer to	Table 1	0
5	9	OR2	MSB of Output Range Select	Refer to	Table 1	0
4	6	OR1	LSB of Output Range Select	Refer to	Table 1	0
3			Hardware/Software Frequency Select	Hardware	Software	0
2			Stop Function	PLL Off	PLL ON	0
1	10	SSON#	Spread Spectrum	Spread On	Spread Off	0
0	4	MW0	LSB of Modulation Width Selection	Refer to	Table 2	0
Data By	rte 5					
7	11	MW2	MSB of Modulation Width Selection	Refer to	Table 2	0
6	14	MW1	Modulation Width Selection Bit	Refer to	Table 2	0
5	20	REFOUT	Output Enable	Disabled	Enabled	1
4	15	SSOUT	Output Enable	Disabled	Enabled	1
3			(Reserved)			0
2			(Reserved)			0
1			(Reserved)			0
0			(Reserved)			0
Data By	vte 6					
7			(Reserved)			0
6			(Reserved)			0
5			(Reserved)			0
4			(Reserved)			0
3			(Reserved)			0
2			(Reserved)			0
1			(Reserved)			0
0			(Reserved)			0
Data By	rte 7					
7			(Reserved)			0
6			(Reserved)			0
5			(Reserved)			0
4			(Reserved)			0
3			(Reserved)			0
2			(Reserved)			0
1			(Reserved)			0
0			(Reserved)			0

## Table 5. Data Bytes 0-7 Serial Configuration Map (continued)



# Absolute Maximum Ratings<sup>[3]</sup>

Stresses greater than those listed in this table may cause permanent damage to the device. These represent a stress rating only. Operation of the device at these or any other conditions above those specified in the operating sections of this specification is not implied. Maximum conditions for extended periods may affect reliability.

Parameter	Description	Rating	Unit
V <sub>DD</sub> , V <sub>IN</sub>	Voltage on any pin with respect to GND	-0.5 to +7.0	V
T <sub>STG</sub>	Storage Temperature	-65 to +150	°C
T <sub>A</sub>	Operating Temperature	0 to +70	°C
Т <sub>В</sub>	Ambient Temperature under Bias	-55 to +125	°C
P <sub>D</sub>	Power Dissipation	0.5	W

## DC Electrical Characteristics: $0^{\circ}C < T_A < 70^{\circ}C$ , $V_{DD} = 3.3V \pm 0.3V$ <sup>[4]</sup>

Parameter	Description	Test Condition	Min.	Тур.	Max.	Unit
I <sub>DD</sub>	Supply Current			18	32	mA
t <sub>ON</sub>	Power Up Time	First locked clock cycle after Power Good			5	ms
V <sub>IL</sub>	Input Low Voltage				0.8	V
V <sub>IH</sub>	Input High Voltage		2.4			V
V <sub>OL</sub>	Output Low Voltage				0.4	V
V <sub>OH</sub>	Output High Voltage		2.4			V
IIL	Input Low Current	Note 4			-100	μΑ
IIH	Input High Current	Note 4			10	μΑ
I <sub>OL</sub>	Output Low Current	@ 0.4V, V <sub>DD</sub> = 3.3V		15		mA
I <sub>OH</sub>	Output High Current	@ 2.4V, V <sub>DD</sub> = 3.3V		15		mA
Cl	Input Capacitance				7	pF
R <sub>P</sub>	Input Pull-Up Resistor			250		kΩ
Z <sub>OUT</sub>	Clock Output Impedance			25		Ω

Note:

Single Power Supply: The voltage on any input or I/O pin cannot exceed the power pin during power up. Inputs OR1:2 and IR1:2 have a pull-up resistor, Input SSON# has a pull-down resistor. 3. 4.



Parameter	Description	Test Condition	Min.	Тур.	Max.	Unit
I <sub>DD</sub>	Supply Current			30	50	mA
t <sub>ON</sub>	Power Up Time	First locked clock cycle after Power Good			5	ms
V <sub>IL</sub>	Input Low Voltage				0.15V <sub>DD</sub>	V
V <sub>IH</sub>	Input High Voltage		0.7V <sub>DD</sub>			V
V <sub>OL</sub>	Output Low Voltage				0.4	V
V <sub>OH</sub>	Output High Voltage		2.4			V
IIL	Input Low Current	Note 4			100	μA
I <sub>IH</sub>	Input High Current	Note 4			10	μΑ
I <sub>OL</sub>	Output Low Current	@ 0.4V, V <sub>DD</sub> = 5V		24		mA
I <sub>OH</sub>	Output High Current	@ 2.4V, V <sub>DD</sub> = 5V		24		mA
CI	Input Capacitance				7	pF
R <sub>P</sub>	Input Pull-Up Resistor			250		kΩ
Z <sub>OUT</sub>	Clock Output Impedance			25		Ω

# DC Electrical Characteristics: 0°C < $T_A$ < 70°C, $V_{DD}$ = 5V ±10%

# AC Electrical Characteristics: $T_A = 0^{\circ}C$ to +70°C, $V_{DD} = 3.3V \pm 0.3V$ or $5V \pm 10\%$

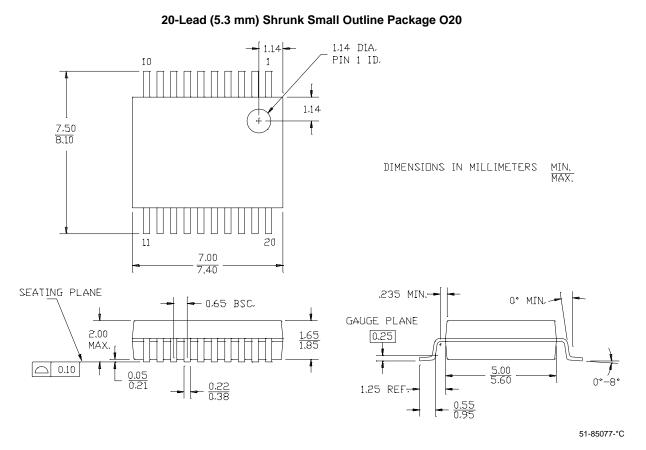
Parameter	Description	Test Condition	Min.	Тур.	Max.	Unit
f <sub>IN</sub>	Input Frequency	Input Clock	14		120	MHz
f <sub>OUT</sub>	Output Frequency	Spread Off	13		120	MHz
t <sub>R</sub>	Output Rise Time	15-pF load, 0.8V–2.4V		2	5	ns
t <sub>F</sub>	Output Fall Time	15-pF load, 2.4V–0.8V		2	5	ns
t <sub>OD</sub>	Output Duty Cycle	15-pF load	40		60	%
t <sub>ID</sub>	Input Duty Cycle		40		60	%
t <sub>JCYC</sub>	Jitter, Cycle-to-Cycle			250	300	ps

## **Ordering Information**

Ordering Code	Package Type	Product Flow
W245-30H	20-Pin Plastic SSOP (209-mil)	Commercial, 0°C to 70°C
W245-30HT	20-Pin Plastic SSOP (209-mil)- Tape and Reel	Commercial, 0°C to 70°C



## Package Drawing and Dimension



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Document Title: W245-30 Frequency Multiplying, Peak Reducing EMI Solution Document Number: 38-07229				
REV.	ECN NO.	Issue Date	Orig. of Change	Description of Change
**	110494	01/07/02	SZV	Change from Spec number: 38-00912 to 38-07229
*A	117404	08/19/02	RGL	Corrected the Ordering Information to match the DevMaster
*В	122693	12/27/02	RBI	Added power up requirements to maximum rating information.